IN



UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Application of:

Tai-Chun Huang Group Art Unit:

Serial No.: 10/731,983 Examiner: David A. Zarneke

Filed: Dec. 10, 2003 In Response to Office Action

Dated: June 7, 2005

2891

For: Structure and Method for Reinforcing a Bond Pad on a Chip

Attorney Docket No.: 67,200-1147

Certificate of Mailing

I hereby certify that this paper is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

RESPONSE TO OFFICE ACTION

Commissioner for Patents Alexandria, VA 22313-1450

Dear Sir:

In response to an Office Action mailed June 7, 2005 of a restriction requirement imposed by the Examiner, the Applicants hereby elect with traverse the prosecution of Species 1, Figure 5, claims 1-4, 9-11, 13-15 and 17-19.